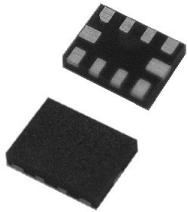


12bit Delta-sigma ADC MM4013A12, MM4014A12, MM4015A12

data sheet

OUTLINE



The MM4013A12, MM4014A12, and MM4015A12 are high-precision, low-power, 12-bit delta sigma analog-to-digital converter ICs with I2C compatible interface. MM4015 can measure two differential inputs or four single-ended inputs by the internal input multiplexer.

MM4014A12 and MM4015A12 have a build-in PGA (programmable gain amplifier), and are well suited for sensor measurement applications because having input voltage range switching function. This ADC operates in either continuous-conversion mode or single-shot conversion mode.

FEATURE

- 3 products line-up : MM4013・MM4014・MM4015
- 12bit Resolution (no missing codes)
- Single-Cycle Setting
- Programmable Data Rate : 128 SPS ~ 3300 SPS
- Multiplexer allows 4 single inputs and 2 differential inputs (MM4015)
- Input voltage range can be changed by installing PGA (MM4014, MM4015)
- Installing Programmable Comparator (MM4014, MM4015)
- Low Current Consumption : 150 μ A (Continuous-Conv. Mode)
- Ultra Small SQFN Package : 2.0(W) x 1.5(D) x 0.4(H) mm
- I2C Interface : 4 different slave address are selectable
- Operation temperature : -40 $^{\circ}$ C ~ +125 $^{\circ}$ C

CONTENT

OUTLINE	1
FEATURE	1
BLOCK DIAGRAM	4
PIN CONFIGURATION	5
TERMINAL EXPLANATIONS	5
ABSOLUTE MAXIMUM RATINGS	7
RECOMMENDED OPERATING CONDITIONS	7
ELECTRICAL CHARACTERISTICS	8
ANALOG INPUT	8
SYSTEM PERFORMANCE	8
DIGITAL INPUT/OUTPUT DC CHARACTERISTICS	9
POWER SUPPLY	9
TIMING CHARACTERISTICS : I2C	10
DETAILED DESCRIPTION	11
OVERVIEW	11
FEATURE DESCRIPTION	11
MULTIPLEXER	11
ANALOG INPUT CIRCUIT	12
FULL — SCALE RANGE (FSR) AND LSB SIZE	12
OUTPUT DATA RATE AND CONVERSION TIME	13
DIGITAL COMPARATOR (MM4014, MM4015)	13
CONVERSION READY PIN (MM4014, MM4015)	15
DEVICE FUNCTION MODES	15
RESET AND POWER — UP	15
POWER — OFF AND REBOOT	15
OPERATING MODES	16
SINGLE — SHOT MODE	16
CONTINUOUS-CONVERSION MODE	16
I2C INTERFACE	17
I2C ADDRESS SELECTION	18
I2C GENERAL CALL	18
Data Format	19
REGISTER MAP	20
ADDRESS POINTER REGISTER (ADDRESS = N/A) [RESET = N/A]	20
CONVERSION REGISTER (P[1:0] = 0H) [RESET = 0000H]	20
CONFIG REGISTER (P[1:0] = 1H) [RESET = 8583H]	21
LO_THRESH (P[1:0] = 2H) [RESET = 8000H] AND HI_THRESH (P[1:0] = 3H) [RESET = 7FFFH] REGISTER	23
TYPICAL APPLICATION CIRCUIT	24
TYPICAL PERFORMANCE CHARACTERISTICS	25
DIMENSIONS	26
MARKING CONTENTS	27
RECOMMENDED LAND PATTERN	28

MOUNTING CONDITION FOR PACKAGE29

 Pb-FREE RECOMMENDED PROFILE CONDITION29

MOUNTING CONDITION FOR PACKAGE30

 STORAGE METHOD30

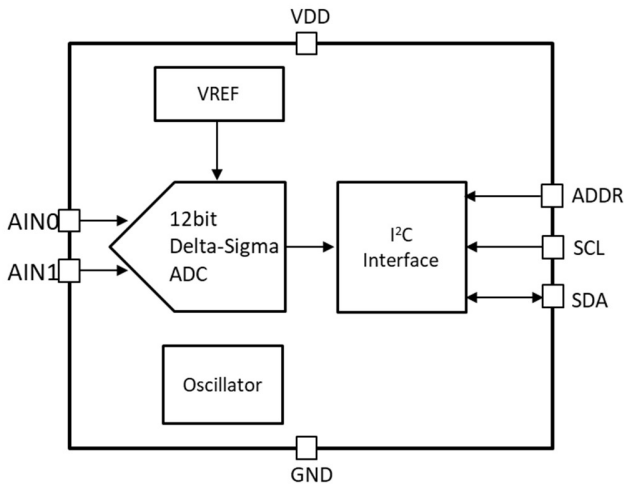
LINE-UP31

NOTES32

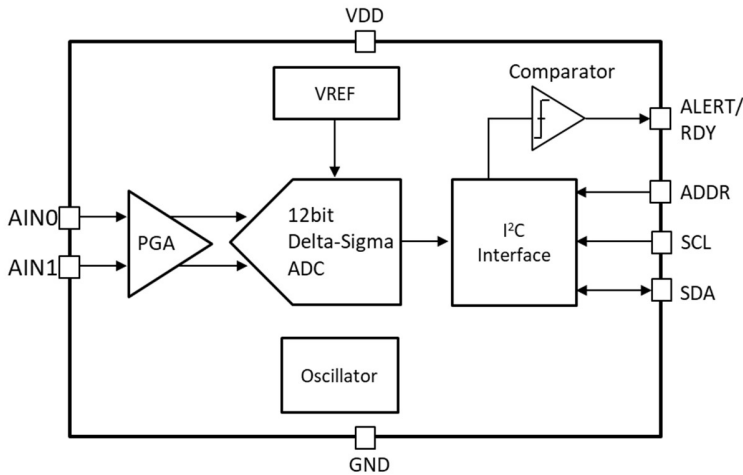
ATTENTION.....33

BLOCK DIAGRAM

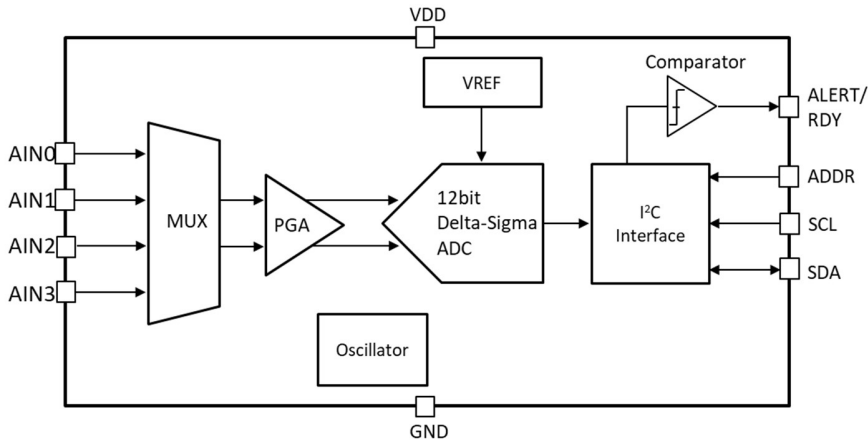
MM4013



MM4014

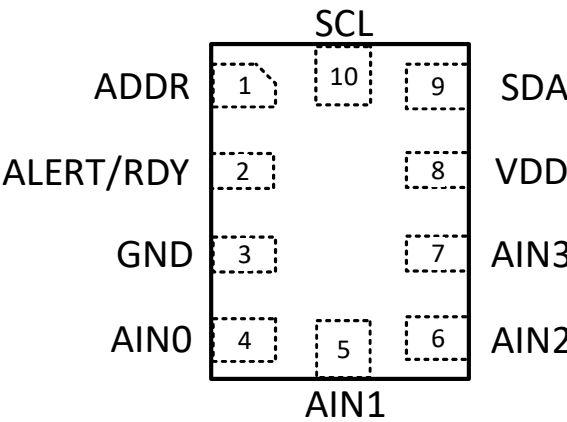


MM4015



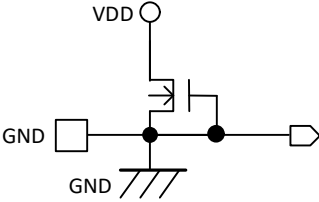
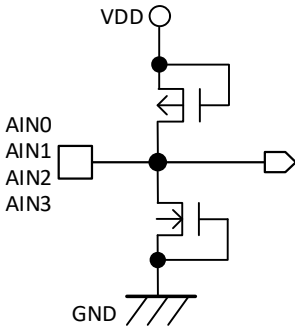
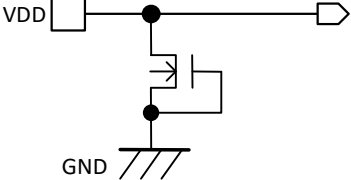
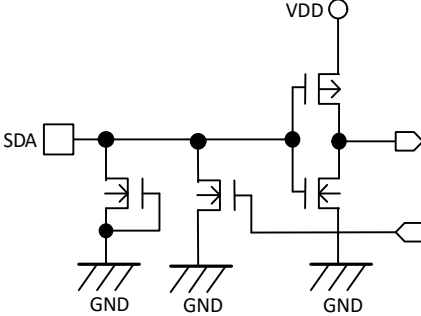
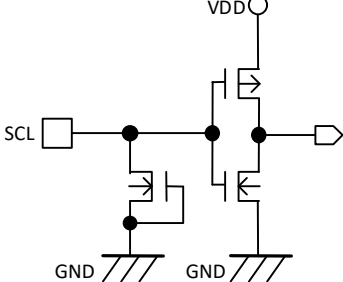
PIN CONFIGURATION

MM4015



TERMINAL EXPLANATIONS

NO	PIN SYMBOL	TYPE	INTERNAL EQUIVALENT CIRCUIT	FUNCTION
1	ADDR	Input		I2C slave address select
2	ALERT/RDY	Output		Comparator output or conversion ready (Open Drain Output) ※MM4013 : Not connected

NO	PIN SYMBOL	TYPE	INTERNAL EQUIVALENT CIRCUIT	FUNCTION
3	GND	Supply		Ground
4	AIN0	Input		Analog input 0
5	AIN1			Analog input 1
6	AIN2			Analog input 2 ※MM4013, MM4014 : Not connected
7	AIN3			Analog input 3 ※MM4013, MM4014 : Not connected
8	VDD	Supply		Power Supply
9	SDA	I/O		Data input/output through I2C serial communication
10	SCL	Input		Clock input through I2C serial communication

ABSOLUTE MAXIMUN RATINGS

Unless otherwise specified
Ta = 25 °C

ITEM	SYMBOL	MIN.	MAX.	UNIT
Power supply voltage	VDD _{abx}	-0.3	7.0	V
Analog input voltage (note ¹)	VAIN _{abx}	GND – 0.3	VDD + 0.3	V
Digital input voltage (note ²)	VDIN _{abx}	GND – 0.3	5.5	V
Continuous input current	Ic _{ntabx}	-10	10	mA
Operating ambient temperature	Ta _{MAX}	-40	125	°C
Junction temperature	Tj _{MAX}	-40	150	°C
Storage temperature	T _{stg}	-60	150	°C
Power dissipation (on board) (note ³)	P _d	-	270	mW

note¹ : AIN0, AIN1, AIN2, AIN3
note² : ADDR, ALERT/RDY, SDA, SCL
note³ : Conditions: 10 mm x 12 mm, t = 1.6 mm, single-sided board, and copper foil 10%

RECOMMENDED OPERATING CONDITIONS

Unless otherwise specified
Ta = 25 °C

ITEM	SYMBOL	MIN.	MAX.	UNIT
Operating ambient temperature	T _{op}	-40	125	°C
Operating voltage	V _{op}	2.0	5.5	V
Analog absolute input voltage (note ¹)	VAIN _x	GND	VDD	V
Full-scale input voltage range (note ²)	FSR	±0.256	±6.144	V
Digital input voltage (note ³)	VDIN _x	GND	5.5	V

note¹ : AIN0, AIN1, AIN2, AIN3
note² : AINP and AINN indicate the selected positive and negative inputs.
note³ : ADDR, ALERT/RDY, SDA, SCL

ELECTRICAL CHARACTERISTICS

Unless otherwise specified
MIN./MAX. Specifications : Ta = -40 to 125 °C, VDD = 3.3 V, DR = 128 SPS, FSR = ±2.048 V
TYP. Specifications : Ta = 25 °C, VDD = 3.3 V, DR = 128 SPS, FSR = ±2.048 V

ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
ANALOG INPUT						
Common-mode input impedance	Zcom	FSR = ±6.144 V	-	>100	-	MΩ
		FSR = ±4.096 V	-	>100	-	
		FSR = ±2.048 V	-	>100	-	
		FSR = ±1.024 V	-	>100	-	
		FSR = ±0.512 V	-	>100	-	
		FSR = ±0.256 V	-	>100	-	
Differential input impedance	Zdiff	FSR = ±6.144 V	-	29	-	MΩ
		FSR = ±4.096 V	-	22	-	
		FSR = ±2.048 V	-	15	-	
		FSR = ±1.024 V	-	10	-	
		FSR = ±0.512 V	-	6	-	
		FSR = ±0.256 V	-	3	-	
SYSTEM PERFORMANCE						
Resolution (note ¹)	Reso		12	-	-	Bits
Data rate	DR		128, 250, 490, 920, 1600, 2400, 3300			SPS
Data rate variation	DR_var	ALL data rates	-10	-	10	%
Integral nonlinearity (note ²)	INL	DR = 128 SPS, FSR = ±2.048 V, Ta = 25 °C	0.5	-	0.5	LSB
Offset error	Erof	FSR = ±2.048 V differential inputs	-0.5	0.0	0.5	LSB
		FSR = ±2.048 V single-ended inputs	-	±0.25	-	LSB
Offset drift over temperature	ΔErof_t	FSR = ±2.048 V	-	0.005	-	LSB/°C
Long-term offset drift	Erof_ltr	FSR = ±2.048 V Ta = 125 °C, 1000 hours	-	±1	-	LSB
Offset channel match	Erof_ch	Match between any two inputs	-	0.25	-	LSB
Gain error	Erga	FSR = ±2.048 V Ta = 25°C	-0.25	0.05	0.25	%
Gain drift over temperature Erga(-40°C)-Erga(125°C) /165°C	ΔErga_t	FSR = ±0.256 V	-	7	-	ppm/°C
		FSR = ±2.048 V	-	5	40	
		FSR = ±6.144 V	-	5	-	

note¹ : Ensured by design.
note² : Best-fit INL; covers 99% of full-scale

Unless otherwise specified

MIN./MAX. Specifications : Ta = -40 to 125 °C, VDD = 3.3 V, DR = 128 SPS, FSR = ±2.048 V

TYP. Specifications : Ta = 25 °C, VDD = 3.3 V, DR = 128 SPS, FSR = ±2.048 V

ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
SYSTEM PERFORMANCE						
Long-term gain drift	Erga_ltr	FSR = ±2.048 V Ta = 125 °C, 1000 hours	-	±0.05	-	%
Gain match	Erga_re	Match between any two gains	-	0.02	0.1	%
Gain channel match	Erga_ch	Match between any two gains	-	0.05	0.1	%
DIGITAL INPUT/OUTPUT DC CHARACTERISTICS						
High-level input voltage	V _{IH}		0.7VDD	-	VDD	V
Low-level input voltage	V _{IL}		GND	-	0.3VDD	V
Low-level output voltage	V _{OL}	I _{OL} = 3mA	GND	0.15	0.4	V
Input leakage current	I _{ILH}	GND < V _{DINx} < VDD	-10	-	10	μA
POWER SUPPLY						
Supply current	I _{dds}	Power-down	-	0.5	-	μA
	I _{ddo}	Operating, Ta=25°C	-	150	200	
		Operating	-	-	300	
Power dissipation	Pop	VDD = 5.0 V	-	0.9	-	mW
		VDD = 3.3 V	-	0.5	-	
		VDD = 2.0 V	-	0.3	-	

TIMING CHARACTERISTICS : I2C

Unless otherwise specified,
Ta = -40 to 125 °C, VDD = 2.0 to 5.5 V

ITEM	SYMBOL	FAST MODE			HIGH-SPEED MODE			UNIT
		MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
I2C Clock frequency	F _{SCL}	0.01	-	0.4	0.01	-	3.4	MHz
Bus free time between START and STOP condition	T _{BUF}	600	-	-	160	-	-	ns
Hold time after repeated START condition.	T _{HDSTA}	600	-	-	160	-	-	ns
Setup time for a repeated START condition	T _{SUSTA}	600	-	-	160	-	-	ns
Setup time for STOP condition	T _{SUSTO}	600	-	-	160	-	-	ns
Data hold time	T _{HDDAT}	0	-	-	0	-	-	ns
Data setup time	T _{SUDAT}	100	-	-	10	-	-	ns
Low period of the SCL clock signal	T _{LOW}	1300	-	-	160	-	-	ns
High period of the SCL clock signal	T _{HIGH}	600	-	-	60	-	-	ns
Rise time for both SDA and SCL signals (note ¹)	T _R	-	-	300	-	-	160	ns
Fall time for both SDA and SCL signals (note ¹)	T _F	-	-	300	-	-	160	ns

note¹ : For the maximum values in high-speed mode, the load capacity of bus line must be less than 400 pF.

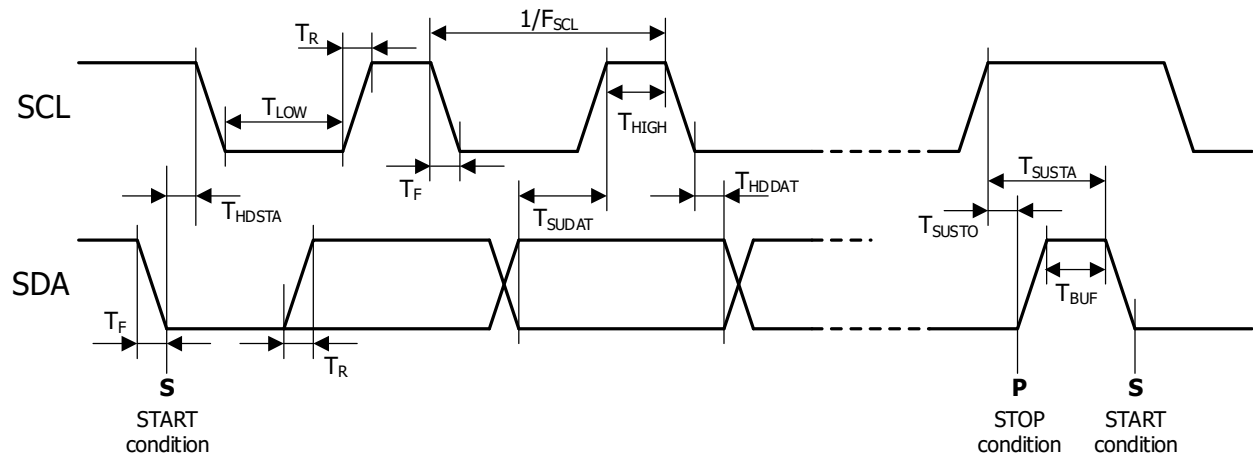


Figure 1. I2C Interface Timing

DETAILED DESCRIPTION

OVERVIEW

The MM4013, MM4014, and MM4015 are 12-bit delta sigma analog-to-digital converter. This consists of a $\Delta\Sigma$ ADC core with an internal reference voltage source, a clock oscillator, and an I2C interface circuit.

MM4014 and MM4015 also have a programmable gain amplifier (PGA) and digital comparator.

FEATURE DESCRIPTION

MULTIPLEXER

MM4015 is equipped with an input multiplexer as shown in Figure 2. This multiplexer can measure two differential signals or four single-ended signals by setting MUX[2:0] in Config register. When measuring the single-ended signal, the negative input of the ADC is internally connected to GND using a switch in the multiplexer.

MM4013 and MM4014 do not have an input multiplexer. It can measure either 1ch differential signals or 1ch single-end signals. For single-end measurements, connect the AIN1 pin externally to the GND.

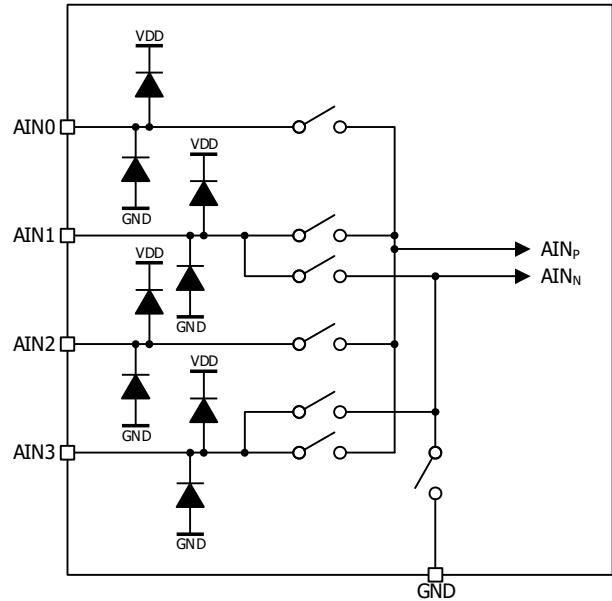


Figure 2. Input Multiplexer

Table 1. Input signal selection

MUX[2:0]	AIN _p	AIN _N
0	AIN0	AIN1
1	AIN0	AIN3
2	AIN1	AIN3
3	AIN2	AIN3
4	AIN0	GND (note ₁)
5	AIN1	GND (note ₁)
6	AIN2	GND (note ₁)
7	AIN3	GND (note ₁)

Note¹ : AINN is connected internally

ANALOG INPUT CIRCUIT

MM4013, MM4014, and MM4015 use a switched-capacitor input stage to sample the voltage between AINP and AINN. In this IC, the input signal is sampled at 250 kHz by the built-in oscillator. The structure of the sampling circuit of the analog input stage can be expressed by the equivalent circuit of Figure 3, and switching is performed at the timing shown in Figure 4. Charge / discharge during this sampling period causes a very small transient current to flow through the analog input pins, and the mean of this current can be used to calculate the effective input impedance (Zcom or Zdiff). The impedance of the analog input may affect the measurement accuracy. The impedance of the signal source should be considered in light of the standard value of the input impedance.

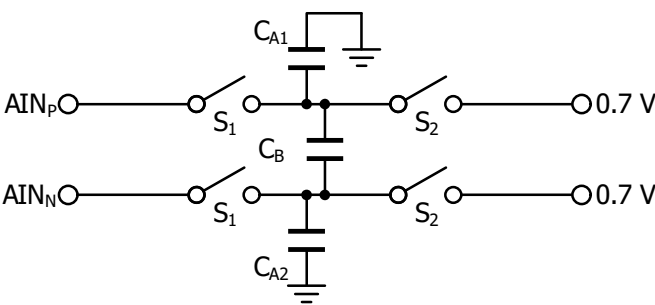


Figure 3. Simplified Analog Input Circuit

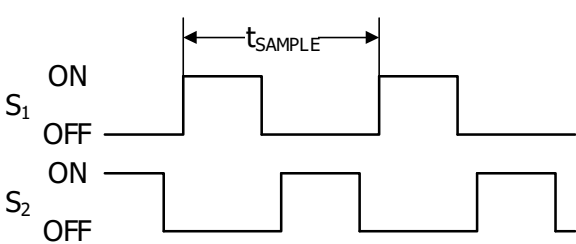


Figure 4. S1 and S2 Switching Timing

FULL—SCALE RANGE (FSR) AND LSB SIZE

For MM4014 and MM4015, a programmable gain amplifier (PGA) is implemented before the ΔΣADC. This allows the magnitude of the minimum resolution (LSB) to be set. Table 2 shows the relation between the full-scale range (FSR = ±6.144 V, ±4.096 V, ±2.048 V, ±1.024 V, ±0.512 V, ±0.256 V) and the LSB. Full scale can be set by PGA[2:0] bits in Config register. In addition, LSB can be calculated from FSR by the equation below.

LSB SIZE = FSR / 2¹²

Table 2. Full-Scale Range and Corresponding LSB Size		
PGA[2:0]	FSR	LSB SIZE
0	±6.144 V	3 mV
1	±4.096 V	2 mV
2	±2.048 V	1 mV
3	±1.024 V	0.5 mV
4	±0.512 V	0.25 mV
5 - 7	±0.256 V	0.125 mV

The analog input voltages must never exceed the analog input voltage limits given in the Absolute Maximum Ratings. If the power supply voltage is less than or equal to the full scale range, the full scale output code of the ADC cannot be obtained.

OUTPUT DATA RATE AND CONVERSION TIME

MM40103, MM4014, and MM4015 can use the DR[2:0] bits in Config register to select the output data rate from the following : 128, 250, 490, 920, 1600, 2400, or 3300 SPS.

Table 3. Data rate selection

DR[2:0]	Data Rate
0	128 SPS
1	250 SPS
2	490 SPS
3	920 SPS
4	1600 SPS
5	2400 SPS
6	3300 SPS
7	3300 SPS

DIGITAL COMPARATOR (MM4014, MM4015)

MM4014 and MM4015 have a programmable digital comparator that can issue an alert from ALERT/RDY pin. Since ALERT/RDY pin is an open-drain pin, a pull-up resistor is required.

The digital comparator has two modes. In traditional comparator mode, ALERT/RDY pin is asserted when the converted data exceeds the limit set in the High-side threshold register (Hi_thresh) (default low-active). It is then deasserted when the conversion data falls below the value set in the Lo side threshold register (Lo_thresh). In window comparator mode, ALERT/RDY pin is asserted when the converted data exceeds the Hi_thresh register value or falls below the Lo_thresh register value.

In both modes, the COMP_LAT bit can be used to latch and hold the state after the assertion. This assertion can be cleared by a SMBus alert-response or by reading Conversion register. (Refer to Figure 6 for SMBus alert response signals.) In this situation, the lowest slave address output from MM4014 and MM4015 are prioritized and deasserted. In traditional comparator mode, the SMBus alert status bit indicates a 1 if the converted data exceeds Hi_thresh. In window comparator mode, the SMBus alert status bit indicates a 1 if the converted data exceed the Hi_thresh, and a 0 if the converted data exceed the Lo_thresh.

The comparator can also be configured to activate ALERT/RDY pin only when the thresholds set in the threshold registers (Hi_thresh and Lo_thresh) are continuously exceeded. The COMP_QUE[1:0] bits in Config register can set the number of times the threshold is continuously exceeded to 1, 2, or 4. The COMP_QUE[1:0] bits can also disable the comparator function and make ALERT/RDY pin to Hi-Z. In addition, the COMP_POL bit in Config register can control High- or low-activation of ALERT/RDY pin.

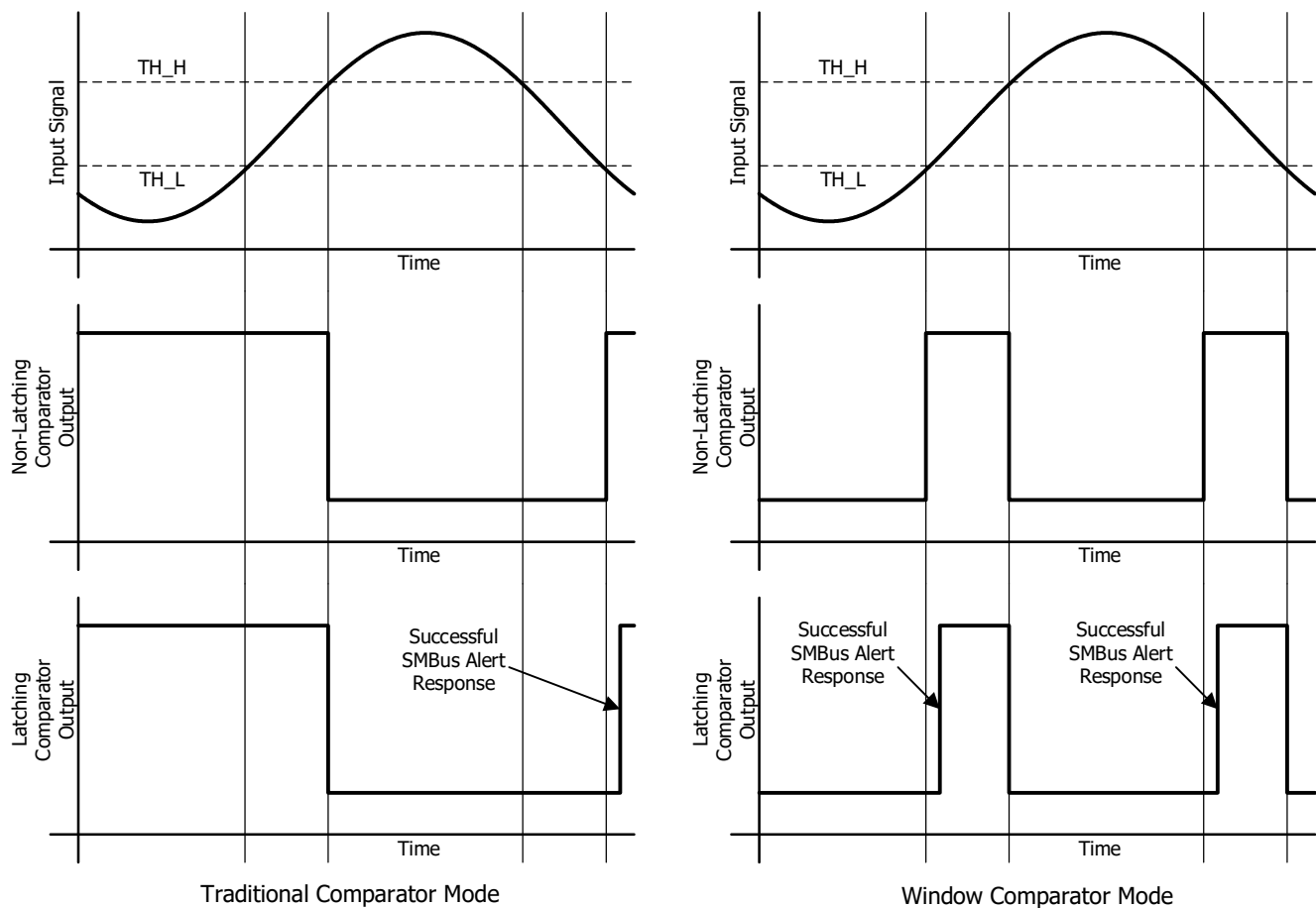


Figure 5. ALERT Pin Timing Diagram

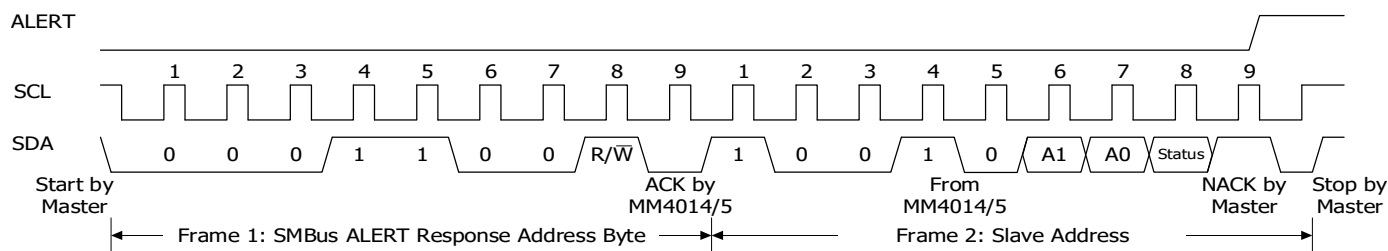


Figure 6. Timing Diagram for SMBus Alert Response

CONVERSION READY PIN (MM4014, MM4015)

ALERT/RDY pin can also be set as a conversion ready pin. Setting the most significant bit of the Hi_thresh register to 1 and the most significant bit of the Lo_thresh register to 0 enables the conversion ready pin. When the COMP_QUE[1:0] bits are set to any 2-bit value other than 11, the conversion ready signal is output from ALERT/RDY pin. At this time, the functionality of the COMP_MODE and COMP_LAT bits is disabled. When this pin is set as a conversion ready pin, a pull-up resistor must be connected to ALERT/RDY pin as well. As shown in Figure 7, MM4014 and MM4015 output approximately 8 us-conversion ready pulses from ALERT/RDY pin at the completion of conversion in continuous conversion mode.

In single-shot mode, when the COMP_POL bit is set to 0, ALERT/RDY pin is asserted to the low-level on completion of the conversion. The polarity of the COMP_POL bit is still valid for this setting.

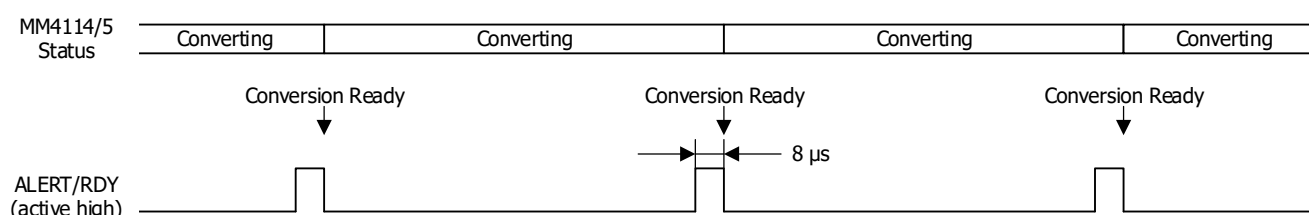


Figure 7. Conversion Ready Pulse in Continuous-Conversion Mode

DEVICE FUNCTION MODES

RESET AND POWER—UP

MM4013, MM4014, and MM4015 initialize at power up and sets all registers to their defaults. This initialization process is completed in about 150 μs, and then automatically goes into the power-down state.

When the I2C general call reset command (06h) is received, the reset processing is executed in the same way as when the device is started.

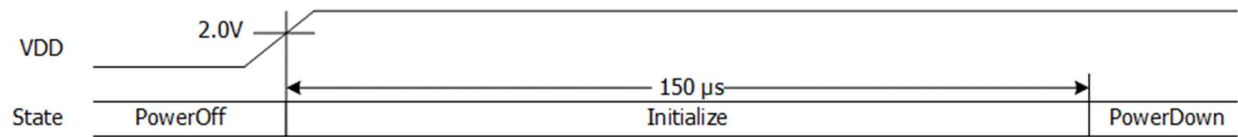


Figure 8. Startup at power on

POWER-OFF AND REBOOT

After power off, MM4015 requires a wait time of 100μs or more for reboot.

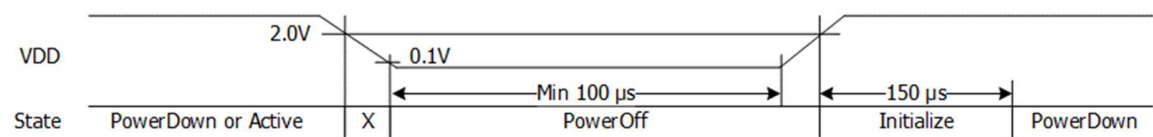


Figure 9. Power off and reboot

OPERATING MODES

MM4013, MM4014, and MM4015 operate either in continuous-transform mode or single-shot mode. The respective operation mode is selected using the MODE bit of Config register.

SINGLE—SHOT MODE

When MODE bit in Config register is set to 1, MM4013, MM4014, and MM4015 set the single-shot mode and powers down the internal circuit. It remains powered down until 1 is written to Operational Status (OS) bit in Config register. When the OS bit is set to 1, the device starts within approximately 25 μ s, resets the OS bit to 0, and performs AD conversion once. After the conversion is completed, the conversion result is stored in Conversion register, and the device goes into the power-down state again. If 1 is written to the OS bit during conversion, the new command is disabled and conversion currently being executed continues. To switch to continuous conversion mode, 0 must be written to MODE bit in Config register.

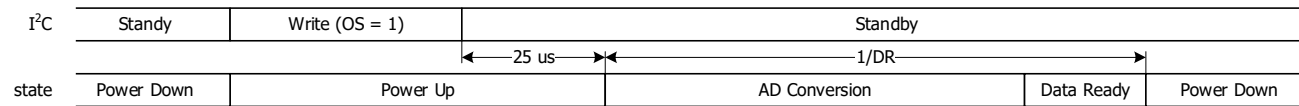


Figure 10. Single-shot conversion

CONTINUOUS-CONVERSION MODE

In continuous conversion mode (MODE bit is set to 0), MM4013, MM4014, and MM4015 perform AD conversion continuously. After the conversion is completed, the result is stored in Conversion register and the next conversion is immediately started. If a new configuration setting is written, the configuration settings of the currently running conversion are retained and the next conversion is performed with the new configuration setting. To switch to single-shot conversion mode, 1 must be written to MODE bit in Config register or reset the device.

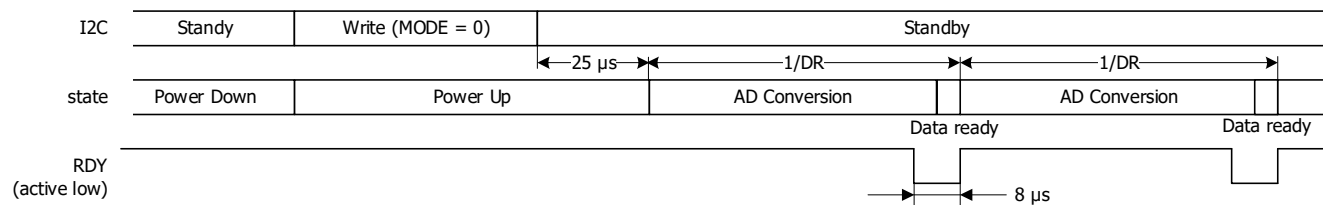


Figure 11. Continuous conversion

I2C INTERFACE

MM4013, MM4014, and MM4015 communicate as slaves on the I2C interfaces. For speed mode, this IC supports standard mode (100 kHz), fast mode (400 kHz), and high speed mode (3.4 MHz). It also supports the I2C bus timeout function, which releases the bus when the bus communication becomes idle (SCL is low) for longer than 25 ms.

Figure 11 and 12 show the read/write sequence in normal mode and fast mode. In the read sequence, the internal register can be read by writing the pointer address and then reading it again. In the write sequence, data can be written after the pointer address is written. Figure 13 shows the sequences in high-speed mode.

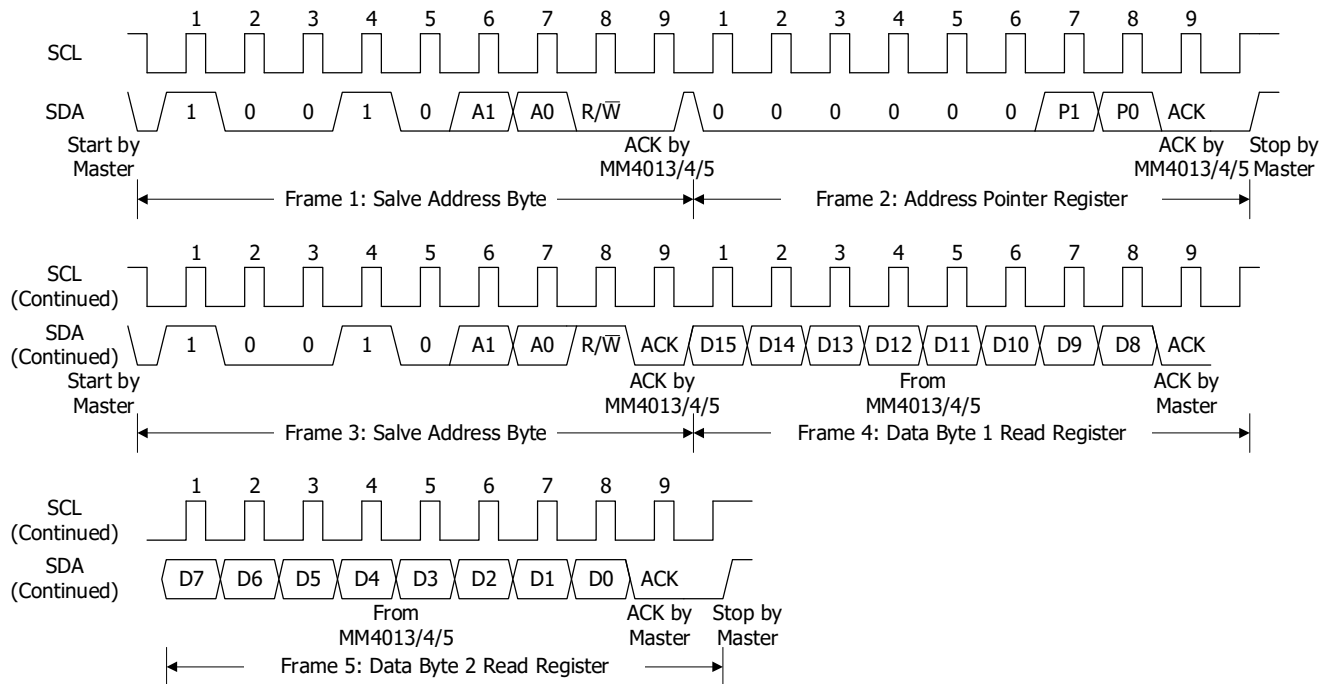


Figure 12. Timing Diagram for Reading from MM4013, MM4014, MM4015

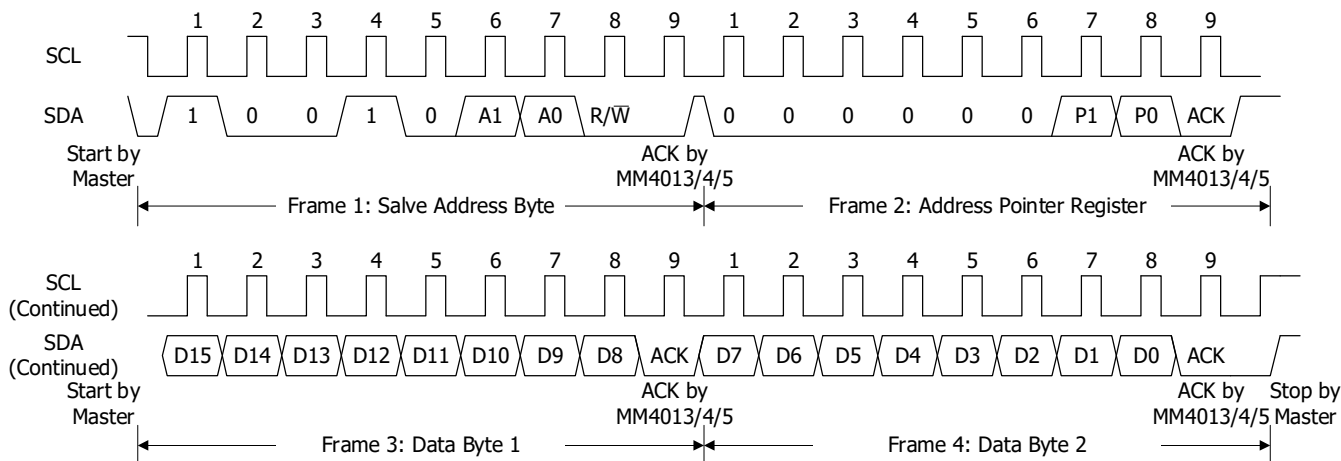
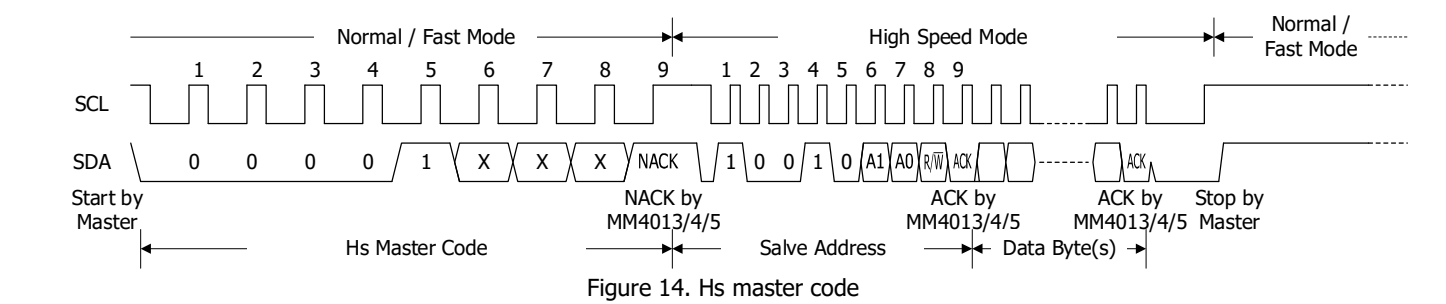


Figure 13. Timing Diagram for Writing to MM4013, MM4014, MM4015



I2C ADDRESS SELECTION

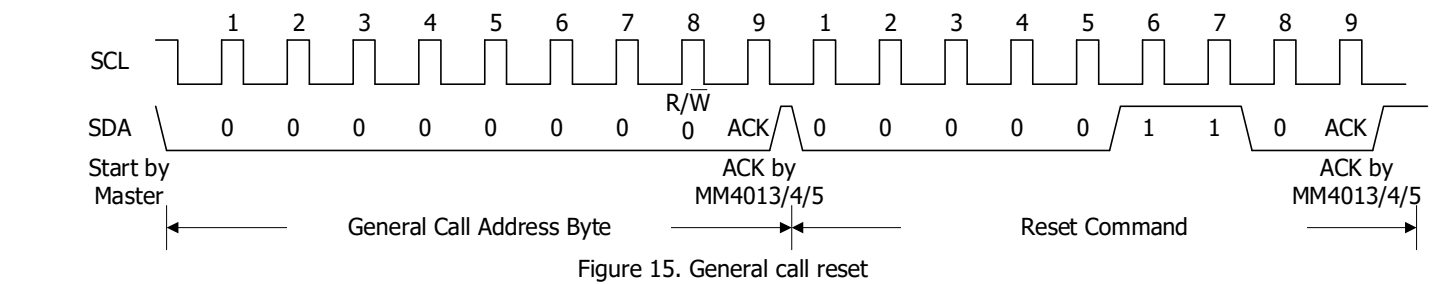
In MM4013, MM4014, and MM4015, ADDR pin is used to set the I2C address of the device. This pin can be connected to GND, VDD, SDA or SCL. As shown in Table 4, four distinct slave addresses can be selected for one pin.

Table 4. ADDR Pin Connection and Corresponding Slave Address

ADDR PIN CONNECTION	SLAVE ADDRESS
GND	100 1000
VDD	100 1001
SDA	100 1010
SCL	100 1011

I2C GENERAL CALL

MM4013, MM4014, and MM4015 respond to an I2C general call (0000 0000). When the general call address is checked and the second byte is 00000110 (06h), MM4013, MM4014, and MM4015 reset the register and enters the power-down state.



Data Format

MM4013, MM4014, and MM4015 converted data is 12-bit data in left-aligned 2's complement format. Table 5 shows the ideal output code for differential inputs. Figure 15 shows the code transitions relative to the input voltage.

Table 5. Input Signal versus Ideal Output Code

INPUT SIGNAL $V_{IN} = V(AIN_P) - V(AIN_N)$	IDEAL OUTPUT CODE
$\geq +FS (2^{11}-1)/2^{11}$	7FF0h
$+FS/2^{11}$	0010h
0	0000h
$-FS/2^{11}$	FFF0h
$\leq -FS$	8000h

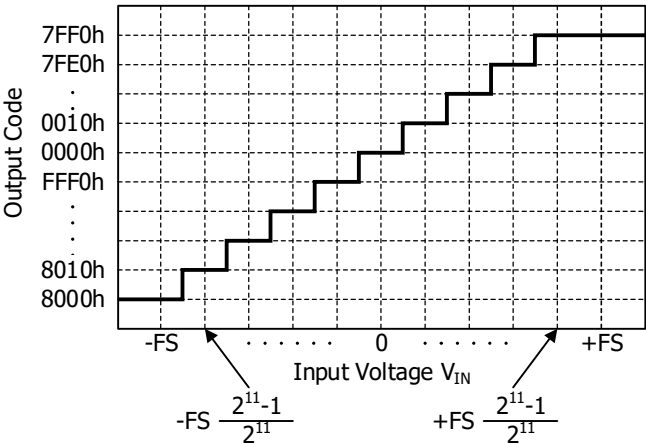


Figure 16. Code Transition Diagram

Only the positive-code range from 0000h to 7FF0h is used to measure single-ended signals. However, if $V(AIN_P)$ is near 0V, the device may output a negative code because of the offset of the device.

REGISTER MAP

MM4013, MM4014, and MM4015 have four registers that can be accessed through the I2C interface. Address Pointer register specifies the access destination. Conversion register stores the ADC-converted data. Config register is used to set the operating mode and check the status. The other two registers (Lo_thresh and Hi_thresh) set the threshold used by the comparator function, but not available on MM4013.

Address Pointer Register (address = N/A) [reset = N/A]

All four registers are accessible by writing to the Address Pointer register. See Table 6.

Table 6. Address Pointer Register

7	6	5	4	3	2	1	0
0	0	0	0	0	0	P[1:0]	
W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	W-0h	

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

Table 7. Address Pointer Register Field Descriptions

Bit	Field	Type	Reset	Description
7:2	Reserved	W	0h	Always write 0h
1:0	P[1:0]	W	0h	Address pointer Register 00 : Conversion Register 01 : Config Register 10 : Lo_thresh Register 11 : Hi_thresh Register

Conversion Register (P[1:0] = 0h) [reset = 0000h]

Conversion register is the two's complement form of the last conversion result. At power-up and reset, Conversion register is cleared to 0 and remains 0 until the first conversion is completed.

Table 8. Conversion Register

15	14	13	12	11	10	9	8
D11	D10	D9	D8	D7	D6	D5	D4
R-00h							
7	6	5	4	3	2	1	0
D3	D2	D1	D0	Reserved			
R-00h				R-0h			

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

Table 9. Conversion Register Field Descriptions

Bit	Field	Type	Reset	Description
15:4	D[11:0]	R	000h	12-bit conversion result
3:0	Reserved	R	0h	Always Read Back 0h

Config Register (P[1:0] = 1h) [reset = 8583h]

Config register is used to control the operation mode, input selection, data rate, full scale range, and comparator mode.

Table 10. Config Register

15	14	13	12	11	10	9	8
OS	MUX[2:0]			PGA[2:0]			MODE
R/W-1h	R/W-0h			R/W-2h			R/W-1h
7	6	5	4	3	2	1	0
DR[2:0]			COMP_MODE	COMP_POL	COMP_LAT	COMP_QUE[1:0]	
R/W-4h			R/W-0h	R/W-0h	R/W-0h	R/W-3h	

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

Table 11. Config Register Field Descriptions

Bit	Field	Type	Reset	Description
15	OS	R/W	1h	<p>This bit determines ADC operation status and starts single-shot conversion.</p> <p>When writing:</p> <p>0 : No effect</p> <p>1 : Start a single conversion (during power-down state)</p> <p>When reading :</p> <p>0 : Conversion is in progress.</p> <p>1 : Conversion is completed.</p>
14:12	MUX[2:0]	R/W	0h	<p>These bits configure the input multiplexer. (MM4015)</p> <p>These bits does not work with MM4013 and MM4014.</p> <p>000 : AIN_P = AIN0 and AIN_N = AIN1 (default)</p> <p>001 : AIN_P = AIN0 and AIN_N = AIN3</p> <p>010 : AIN_P = AIN1 and AIN_N = AIN3</p> <p>011 : AIN_P = AIN2 and AIN_N = AIN3</p> <p>100 : AIN_P = AIN0 and AIN_N = GND</p> <p>101 : AIN_P = AIN1 and AIN_N = GND</p> <p>110 : AIN_P = AIN2 and AIN_N = GND</p> <p>111 : AIN_P = AIN3 and AIN_N = GND</p>
11:9	PGA[2:0]	R/W	2h	<p>These bits set gain amplifier. (MM4014, MM4015)</p> <p>These bits does not work with MM4013.</p> <p>000 : FSR = ±6.144 V (note¹)</p> <p>001 : FSR = ±4.096 V (note¹)</p> <p>010 : FSR = ±2.048 V (default)</p> <p>011 : FSR = ±1.024 V</p> <p>100 : FSR = ±0.512 V</p> <p>101 : FSR = ±0.256 V</p> <p>110 : FSR = ±0.256 V</p> <p>111 : FSR = ±0.256 V</p>

note¹ : This parameter expresses the full-scale range of the ADC scaling. Do not apply more than VDD + 0.3 V to the analog input of the device.

Bit	Field	Type	Reset	Description
8	MODE	R/W	1h	This bit sets ADC operating mode. 0 : Continuous-conversion mode 1 : Single-shot mode or power-down state (default)
7:5	DR[2:0]	R/W	4h	These bits set conversion data rate. 000 : 128 SPS 001 : 250 SPS 010 : 490 SPS 011 : 920 SPS 100 : 1600 SPS (default) 101 : 2400 SPS 110 : 3300 SPS 111 : 3300 SPS
4	COMP_MODE	R/W	0h	This bit sets the comparator mode. (MM4014, MM4015) This bit does not work with MM4013. 0 : Traditional comparator (default) 1 : Window comparator
3	COMP_POL	R/W	0h	This bit sets the polarity of the ALERT/RDY pin. (MM4014, MM4015) This bit does not work with MM4013. 0 : Active low (default) 1 : Active high
2	COMP_LAT	R/W	0h	This bit sets whether the ALERT/RDY pin latches. (MM4014, MM4015) This bit does not work with MM4013. 0 : Non-latching comparator (default). 1 : Latching comparator
1:0	COMP_QUE[1:0]	R/W	3h	These bits specify comparator judgment count and comparator usage. (MM4014, MM4015) These bits does not work with MM4013. 00 : Assert after one conversion 01 : Assert after two conversions 10 : Assert after four conversions 11 : Disable comparator and set ALERT/RDY pin to high-impedance (default)

Lo_thresh (P[1:0] = 2h)[reset = 8000h] and Hi_thresh (P[1:0] = 3h)[reset = 7FFFh] Register

Lo_thresh and Hi_thresh registers are used to store the comparator upper and lower limits of the thresholds. The output of this comparator is determined by comparing the ADC conversion result with the value of this register. For this reason, the register value of Hi_thresh must always be greater than that of Lo_thresh.

To use the conversion ready function, the MSB of Hi_thresh must be set to 1 and the MSB of Lo_thresh to 0. ALERT/RDY pin outputs the OS bit in single-shot mode and Conversion Ready pulses in continuous-conversion mode.

Table 12. Lo_thresh Register

15	14	13	12	11	10	9	8
Lo_thresh11	Lo_thresh10	Lo_thresh9	Lo_thresh8	Lo_thresh7	Lo_thresh6	Lo_thresh5	Lo_thresh4
R/W-80h							
7	6	5	4	3	2	1	0
Lo_thresh3	Lo_thresh2	Lo_thresh1	Lo_thresh0	0	0	0	0
R/W-0h				R-0h			

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

Table 13. Hi_thresh Register

15	14	13	12	11	10	9	8
Hi_thresh11	Hi_thresh10	Hi_thresh9	Hi_thresh8	Hi_thresh7	Hi_thresh6	Hi_thresh5	Hi_thresh4
R/W-7Fh							
7	6	5	4	3	2	1	0
Hi_thresh3	Hi_thresh2	Hi_thresh1	Hi_thresh0	1	1	1	1
R/W-Fh				R-Fh			

LEGEND: R/W = Read/Write; R = Read only; W = Write only; -n = value after reset

Table 14. Lo_thresh and Hi_thresh Register Field Descriptions

Bit	Field	Type	Reset	Description
15:4	Lo_thresh [11:0]	R/W	800h	Low threshold value
15:4	Hi_thresh [11:0]	R/W	7FFh	High threshold value

TYPICAL APPLICATION CIRCUIT

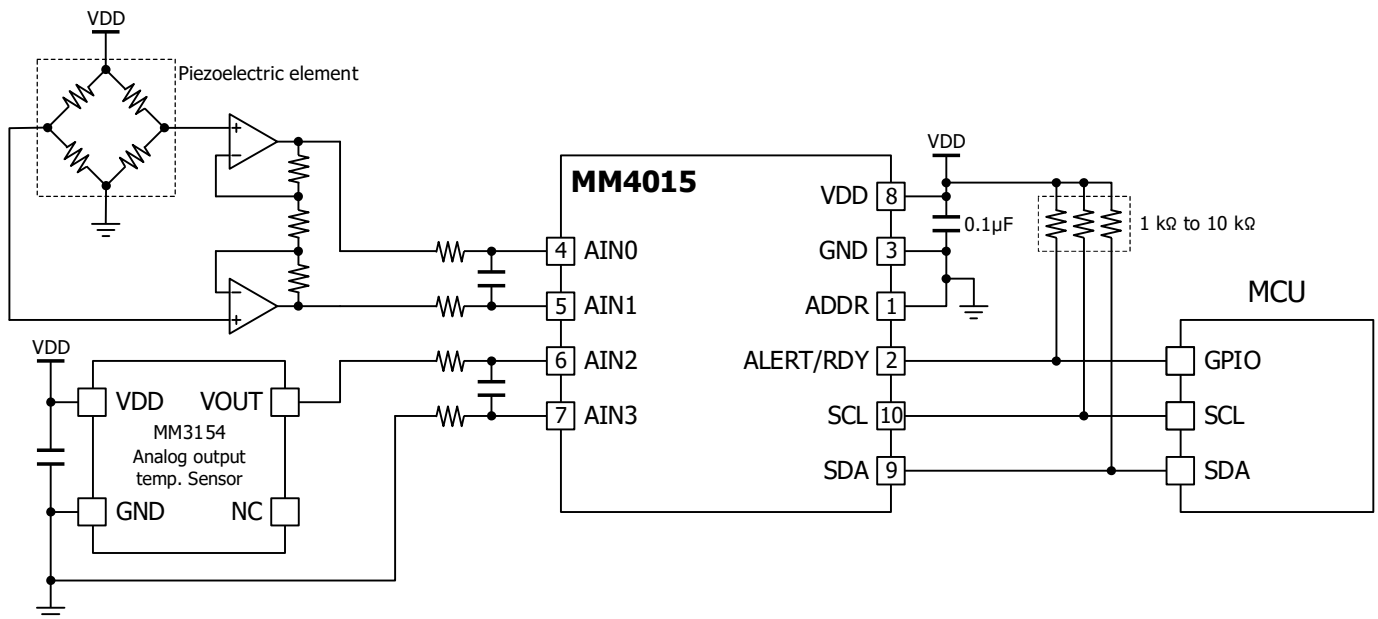


Figure 17. Typical application circuit

APPLICATION HINTS

Transient current flows through MM4013/14/15 during conversion. Connecting a 0.1 µF power supply bypass capacitor absorbs instantaneous current changes and improves tolerance to fluctuations in power supply voltage and noise generation.

Connection of the analog input must be done with sufficiently small output impedance compared to input impedance of the data rate to use. In addition, connecting a low-pass filter to the input reduces the effects of folding distortion and external noise. It is recommended that these constants be checked on the actual machine.

The I2C bus pins of SDA and SCL to VDD must be connected using a pull-up resistor of 1 to 10 kΩ. The resistance value of the resistor to connect must be selected considering the wiring capacitance and data rate of the I2C bus.

Analogue inputs of MM4013/14/15 have protective diodes. However, the current processing capacity of these diodes is limited and applying an analog input voltage to the power rail for extended periods of time in excess of approximately 300 mV may cause permanent damages.

Un used analog input pins must be unconnected or connected to VDD, GND, or intermediate potential.
When ALERT/RDY output pin is not used, it must be unconnected or connected to VDD using a pull-up resistor.

TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise specified
Ta = 25 °C, VDD = 3.3 V, FSR = ±2.048 V, DR = 128 SPS

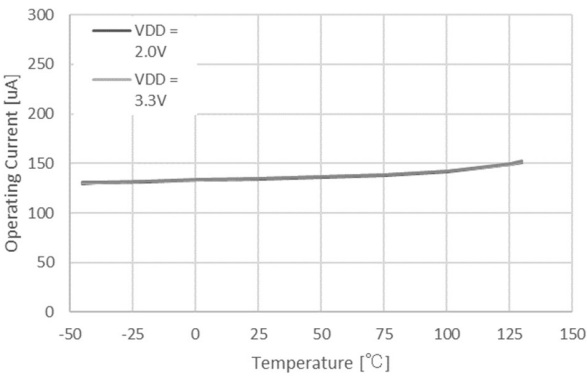


Figure 18. Operating Current vs Temperature

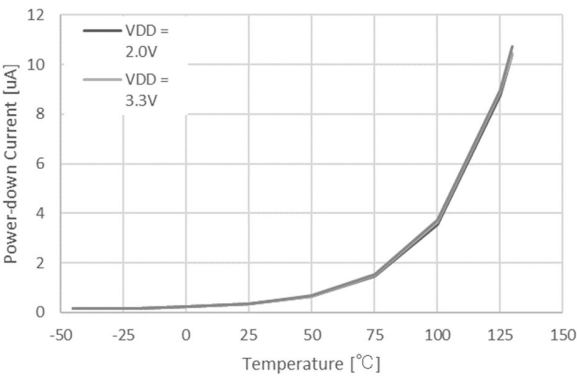


Figure 20. Power-Down Current vs Temperature

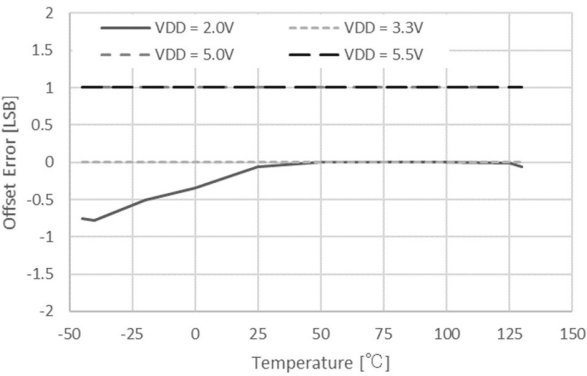


Figure 19. OffsetError vs Temperature

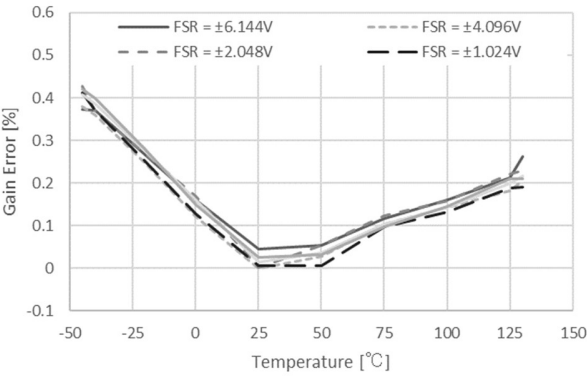
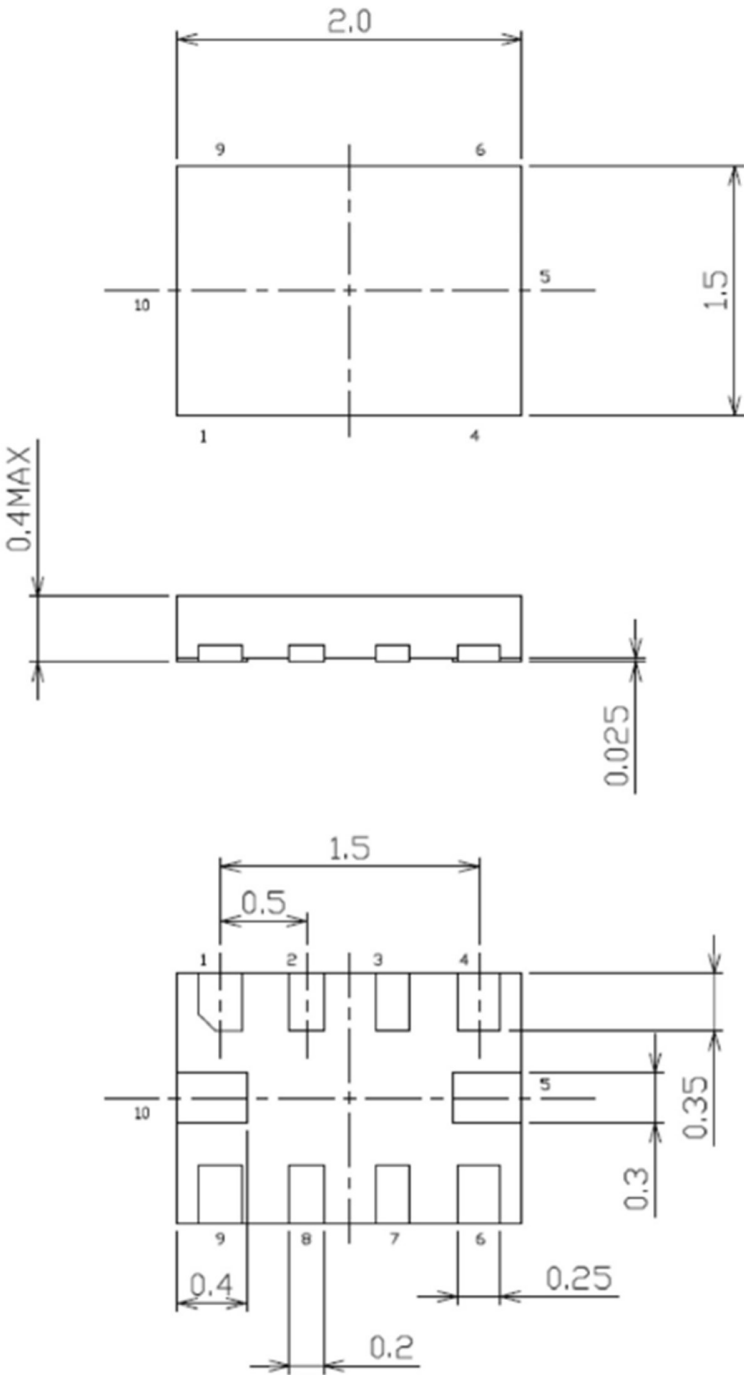


Figure 21. GainError vs Temperature

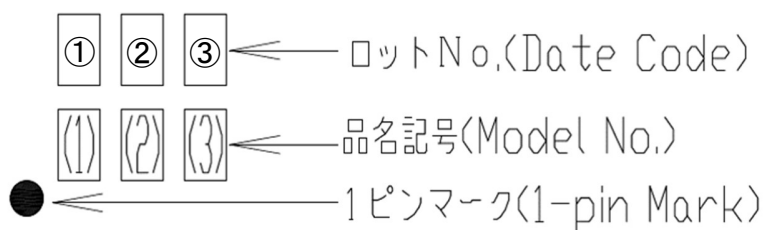
DIMENSIONS

パッケージ: SQFN-10
PACKAGE

UNIT	mm
------	----



MARKING CONTENTS



Model Name	Model No		
	(1)	(2)	(3)
MM4013A12Rxx	0	1	3
MM4014A12Rxx	0	1	4
MM4015A12Rxx	0	1	5

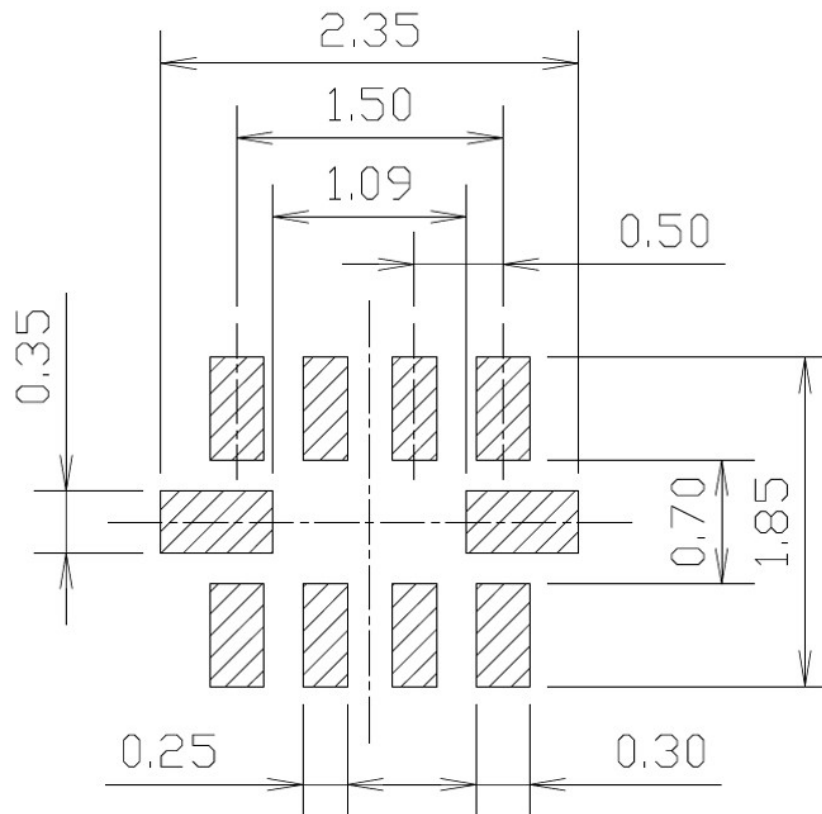
【生産年の表記方法/How to indicate a production year】

1桁目(①)/The 1st digit (①)	
西暦年末尾 the last digit of a production year	使用表示文字 mark
xxx1	1
xxx2	2
xxx3	3
xxx4	4
xxx5	5
xxx6	6
xxx7	7
xxx8	8
xxx9	9
xxx0	0

2桁目、及び3桁目(②③)/The 2nd and 3rd digit (②③)			
生産週 production week	使用表示文字 mark	生産週 production week	使用表示文字 mark
1	01	27	27
2	02	28	28
3	03	29	29
4	04	30	30
5	05	31	31
6	06	32	32
7	07	33	33
8	08	34	34
9	09	35	35
10	10	36	36
11	11	37	37
12	12	38	38
13	13	39	39
14	14	40	40
15	15	41	41
16	16	42	42
17	17	43	43
18	18	44	44
19	19	45	45
20	20	46	46
21	21	47	47
22	22	48	48
23	23	49	49
24	24	50	50
25	25	51	51
26	26	52	52
		53	53

RECOMMENDED LAND PATTERN

UNIT mm

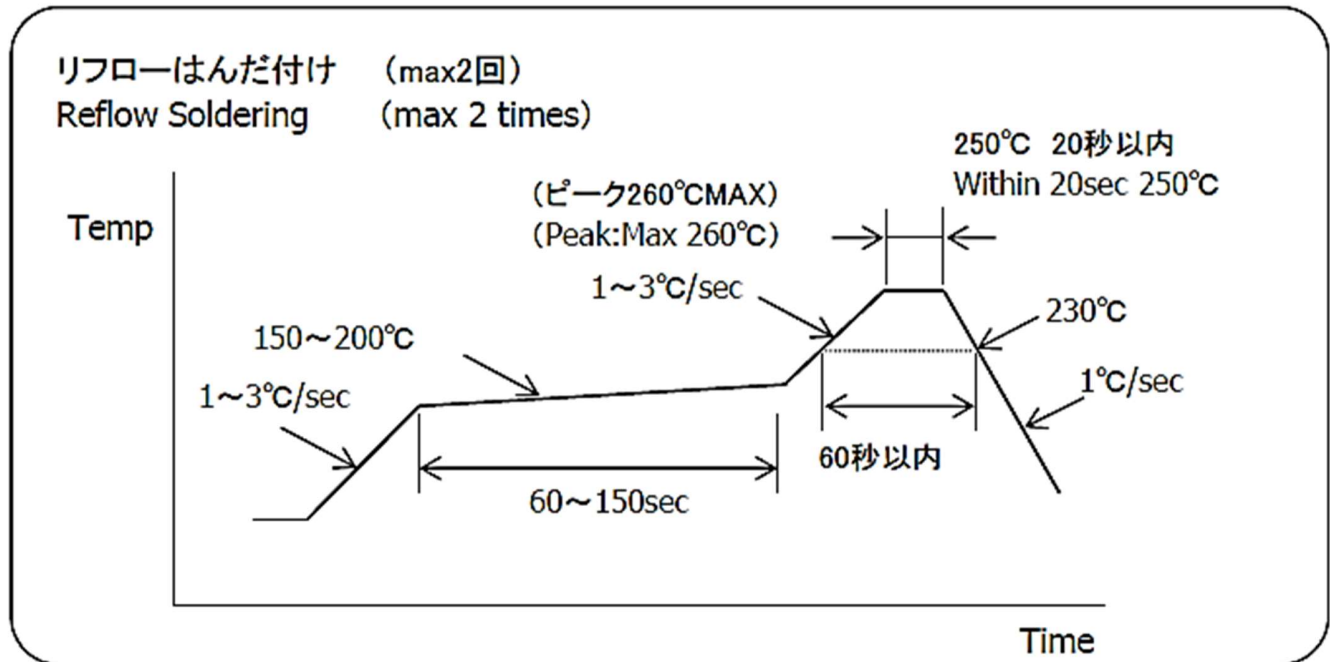


The dimension are for reference only and not guaranteed by design.

To design practically, correction should be made for optimized dimensions considering the effects of the board type to be mounted, mount (soldering) method, type and coating thickness of cream solder.

MOUNTING CONDITION FOR PACKAGE

Pb-Free recommended profile condition



This profile gives recommended values, which are not guaranteed.
For mounting the package, evaluate the profile with the equipment, conditions, and materials to be used.

- Mounting by flow soldering
Flow soldering cannot be used for mounting of this package.
- Mounting by manual soldering
Manual soldering cannot be used for mounting of this package.

MOUNTING CONDITION FOR PACKAGE

Storage method

【Storage condition】

Store the device under the following conditions.

Temperature : 5 to 30 °C

Humidity : 40 to 70 %RH

Storage life : 1 year

Do not store this device where a large amount of dust or harmful volatile gas exists, electrostatic is easily charged, condensation is generated, or changes in temperature and humidity are wide, or under the direct sunlight.

【Baking】

If the storage time specified above has passed, mounting by soldering may cause cracks on the moistureabsorbed package. Before mounting, the package should be baked under the following conditions.

Temperature : 125 °C

Storage life : 16 to 24 hours

Embossing tapes and reels are not heat-resistant type.

Before baking, the device should be placed in a heat-resistant container.

In consideration of the time-consuming baking process and the possibility of deformed terminal, the device should be mounted promptly within the time observing the storage conditions.

If a long-term storage is needed, a desiccator or a dry box should be used.

【Handling instructions】

Shipping boxes must be handled with care because any drop or shock may damage the device.

Additionally, the device must be handled in the place with the protection against electrostatic charge and without extreme changes of temperature/humidity.

LINE-UP

Device	Resolution	Data rate	Input channels		PGA	Digital comparator	Interface
			Differential	Single-End			
MM4113	16Bit	8 ~ 860 SPS	1	1	No	No	I2C
MM4114	16Bit	8 ~ 860 SPS	1	1	Yes	Yes	I2C
MM4115	16Bit	8 ~ 860 SPS	2	4	Yes	Yes	I2C
MM4013	12Bit	128 ~ 3300 SPS	1	1	No	No	I2C
MM4014	12Bit	128 ~ 3300 SPS	1	1	Yes	Yes	I2C
MM4015	12Bit	128 ~ 3300 SPS	2	4	Yes	Yes	I2C

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- Before using this product, please evaluate and confirm the actual application with this product mounted and embedded.
- To investigate the influence by applied transient load or external noise, It is necessary to evaluate and confirm them with mounting this product to the actual application.
- Any usage above the maximum rating may destroy this product or shorten the lifetime. Be sure to use this product under the maximum rating.
- If you continue to use this product highly-loaded (applying high temperature, large current or high voltage; or variation of temperature) even under the absolute maximum rating and even in the operating range, the reliability of this product may decrease significantly. Please design appropriate reliability in consideration of power dissipation and voltage corresponding to the temperature and designed lifetime after confirming our individual reliability documents (such as reliability test report or estimated failure rate). It is recommended that, before using this product, you appropriately derate the maximum power dissipation (typically, 80% or less of the maximum value) considering parameters including ambient temperature, input voltage, and output current.

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 - Environment with high temperature or high humidity where dew condensation may occur
- This product is not designed to withstand radioactivity, and must avoid using in a radioactive environment.

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Strategy Engineering Department Semiconductor Business Division

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